This document explains the function of the Backplane, its schematic level design, and its board level design

Backplane

Backplane Design

Revision: 3.1.1

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1 Introduction

This document explains how the Backplane will fulfil the following Functions and Requirements. This document refers to the Backplane version 3.1.0.

1.1 Function

The Backplane connects all the subsystems of the satellite together via a parallel bus and interchangeable cards.

1.2 Requirements

The system requirements and EPS design requirements can be found on GitHub.





2 Detailed Description

This section references the Backplane schematic. Page numbers will be listed and may have coordinates listed (number and letter combination found around the frame).

2.1 Functional Block Diagram

The block diagram can be found on the first page of the schematic.

Card Slots

The Backplane has eight slots connected in parallel. Each slot is electrically identical. Any card is compatible with every slot.

2.1.2 Separation Switch

The separation switch connects via a connector to the Backplane.

2.2 Schematic

2.2.1 Isolated Grounds

On page 2 of the schematic (D1), are the two isolated grounds found on the Backplane. Power ground (PGND) is directly connected to the card. The other grounds are shorted to PGND using a 0Ω resistor rated up to 2A, the expected current is less than 50mA each. Chassis ground (CHASSIS[1:2]) is connected to the conductive Mechanical Features including bolt holes.

2.2.2 Separation Switching

There are two identical connectors to connect to the separation switches. The CubeSat requirements specify at least one separation switch, either or both connectors can be used. The switch is normal open and shorts to *PGND* when depressed.

2.2.3 Cord Connectors

Each card connector is a PCIe socket with 98 pins. See Table 1 for the pin allocation. Each power rail has two pins in parallel which allows loads rated up to 1A. Each I2C and SPI data signal has two pins in parallel which increases redundancy¹.

Table 1: Connector Pinout

Pins	Pin Name	Description
A1, B1	PR_3.3V-0	Power Rail 3.3V - Channel 0
A2, B2	PR_3.3V-1	Power Rail 3.3V - Channel 1
A3, B3	PR_3.3V-2	Power Rail 3.3V - Channel 2
A4, B4	PR_3.3V-3	Power Rail 3.3V - Channel 3
A5, B5	PR_3.3V-4	Power Rail 3.3V - Channel 4
A6, B6	PR_3.3V-5	Power Rail 3.3V - Channel 5

¹ REQ-009





D.	LD: Al			
Pins	Pin Name	Description		
A7, B7	PR_3.3V-6	Power Rail 3.3V - Channel 6		
A8, B8	PR_3.3V-7	Power Rail 3.3V - Channel 7		
A9, B9	PR_3.3V-8	Power Rail 3.3V - Channel 8		
A10, B10	PR_3.3V-9	Power Rail 3.3V - Channel 9		
A11, B11	PR_3.3V-10	Power Rail 3.3V - Channel 10		
A12, B12	PR 3.3V-11	Power Rail 3.3V - Channel 11		
A13, B13	PR 3.3V-12	Power Rail 3.3V - Channel 12		
A14, B14	PR BATT-0	Power Rail Vbatt - Channel 0		
A15, B15	PR BATT-1	Power Rail Vbatt - Channel 1		
A16, B16	PR BATT-2	Power Rail Voatt - Channel 2		
A17, B17	PR BATT-3	Power Rail Vbatt - Channel 3		
A18, B18	PR_BATT-4	Power Rail Vbatt - Channel 4		
A19, B19	_	Power Rail Voatt - Channel 5		
	PR_BATT-5			
A20, B20	PR_BATT-6	Power Rail Vbatt - Channel 6		
A21-23	PGND	Global ground potential.		
B21-29		- '		
A40, B40	PWR_CTRL_SW	Disconnects battery (active low), driven by		
		deployment switch OR RBF pin		
A43, B43	BUS_I2CO_SDA	I2C interfaces for bidirectional data exchange among		
A44, B44	BUS_I2C0_SCL	high priority devices		
A45, B45	BUS_I2C0_IRQ	7.1.g. (2.1.1.)		
A30, B30	BUS_I2C1_SDA	I2C interfaces for bidirectional data exchange among		
A31, B31	BUS_I2C1_SCL	low priority devices		
A32, B32	BUS_I2C1_IRQ	tow priority devices		
A37, B37	BUS_SPI_SCK	SPI interface to subsystem or direct access to remote serial device		
A38, B38	BUS_SPI_MISO			
A39, B39	BUS SPI MOSI			
A42, B42	CTRL_SYNC	Global synchronization signal, driven by IHU		
A33, B33	_	Serial interface for dedicated communication with		
7.55, 555	COM_SPI_SCK	the Comms		
A34, B34	COM SPI MISO	Serial interface for dedicated communication with		
A35, B35	COM SPI MOSI	the Comms		
A36, B36	COM SPI CS	Shared JTAG interface for subsystem software		
A46		update via IFJR. Max 1 device at a time, normally high		
	BUS_JTAG_TCK	impedance		
A47	BUS_JTAG_TDI	Shared JTAG interface for subsystem software		
A48	BUS_JTAG_TDO	update via IFJR. Max 1 device at a time, normally high		
A49	BUS JTAG TMS	impedance , , , , , , , , , , , , , , , , , , ,		
B46	BUS JTAG EN-0	JTAG SEL COMMS		
B47	BUS JTAG EN-1	JTAG SEL PMIC		
B48	BUS JTAG EN-2			
B49	BUS_JTAG_EN-3			
A24	GPIO-0	SPI EN CAMO		
	GPIO-0			
A25		SPI_EN_CAM1		
A26	GPIO-2	SPI_EN_CAM2 (Germination Chamber Camera)		
A27	GPIO-3	PWM_LIGHTING (Germination Chamber Lighting)		
A28	GPIO-4	PWM_HEATER (Germination Chamber Heater)		
A29	GPIO-5			





Pins	Pin Name	Description
A41	GPIO-6	
B41	GPIO-7	

2.2.4 Mechanical Features

The Backplane mounts to the Structure using two bolts (page 5, D1) and the top and bottom edges. Each of the holes have a capacitor and resistor connecting to power ground which will absorb transients.

2.3 Board

The board shall be double layered with 2 oz copper and ENIG finish.

2.3.1 Layout Constraints

Unless specified in the following subsections, all signals shall use the default minimum parameters below. Signals in the following subsections do not include their sense signals unless specified. Trace width can be broken if a trace needs to bottleneck down to a pin, the bottleneck shall be minimized.

Trace width: 0.16mm

Vias: $\emptyset 0.3mm$, unlimited count

Separation: 0.16mm Length: unlimited

Devices with specific placement and routing considerations are called out on the schematic, see "CAD Note:"

2.3.1.1 Power Channels - PR_3.3V-[0:12], PR_BATT-[0:6]

Trace width: 0.5mm

2.3.1.2 Power Ground - PGND

Trace width: 3.0mm

2.3.1.3 Data Lines

Length: Each node shall be length matched $\pm 10.0mm$

Stubs: < 10.0*mm*





3 Testing

All tests shall be performed at room temperature and not under vacuum unless otherwise specified. If any modifications are performed, take note. Include enough information to understand circuit behavior and for others to replicate the results. Include any software written to execute the test and link it in the test notes section. Save all software, waveforms, etc. in a subfolder of the board's test folder for each test².

- Waveforms shall be captured whenever appropriate
- Have the event take fill the screen (for fast events, zoom in; for slow events, zoom out)
- Label each channel accurately
- Only have bandwidth limiting if necessary for the test (this applies to the oscilloscope and probe settings)
- If ringing or overshoot occurs, use a ground spring or differential probe

Results location: https://github.com/CougsInSpace/CougSat1- Hardware/tree/master/CougSat1-Backplane/Testing/Backplane.3.0

Common test instructions can be found on the wiki.

3.1 Separation Switching

Results: Pass

Test Configuration: Elvis

This test evaluates the circuit described in Separation Switching.

3.1.1 Test Instructions

Connect the separation switch to each connector. Measure the resistance between *PWR_CTRL_SW* and *PGND* in all switch states.

3.1.2 Test Data

Measure the resistance between <i>PWR_CTRL_SW</i> and <i>PGND</i> in both switch states.					
Switch	n State	Resistance	Passing Criteria	Pass / Fail	
J5	J6	Resistance	russing Cinteria	Puss / I uit	
Released	Released	$> 100 M\Omega$	Resistance > $10M\Omega$	Pass	
Released	Depressed	$\Omega 8.0$	Resistance < 10Ω	Pass	
Depressed	Released	0.8Ω	Resistance < 10Ω	Pass	
Depressed	Depressed	0.6Ω	Resistance < 10Ω	Pass	

3.2 Continuity

Results: Pass

Test Configuration: Elvis

² For test 3.1, place files in the subfolder *"3.1"* and so on





This test evaluates the circuit described in Card Connectors.

3.2.1 Test Instructions

Measure the resistance of each power channel and the power ground from Slot 0 to Slot 4 (from bottom to top slot). Measure on the card, at the connector.

3.2.2 Test Data

Measure the resistance between each power channel and the power ground from Slot 0 to Slot 7.			
Power Channel	Resistance	Passing Criteria	Pass / Fail
PGND		Resistance < $100m\Omega$	
PR_3.3V-0		Resistance < $100m\Omega$	
PR_3.3V-1		Resistance < $100m\Omega$	
PR_3.3V-2		Resistance < $100m\Omega$	
PR_3.3V-3		Resistance < $100m\Omega$	
PR_3.3V-4		Resistance < $100m\Omega$	
PR_3.3V-5		Resistance < $100m\Omega$	
PR_3.3V-6		Resistance < $100m\Omega$	
PR_3.3V-7		Resistance < $100m\Omega$	
PR_3.3V-8		Resistance < $100m\Omega$	
PR_3.3V-9		Resistance < $100m\Omega$	
PR_3.3V-10		Resistance < $100m\Omega$	
PR_3.3V-11		Resistance < $100m\Omega$	
PR_3.3V-12		Resistance < $100m\Omega$	
PR_BATT-0		Resistance < $100m\Omega$	
PR_BATT-1		Resistance < $100m\Omega$	
PR_BATT-2		Resistance < $100m\Omega$	
PR_BATT-3		Resistance < $100m\Omega$	
PR_BATT-4		Resistance < $100m\Omega$	
PR_BATT-5		Resistance < $100m\Omega$	
PR_BATT-6		Resistance $< 100m\Omega$	
PWR_CTRL_SW		Resistance $< 300 m\Omega$	
BUS_I2C0_SDA		Resistance $< 300 m\Omega$	
BUS_I2C0_SCL		Resistance $< 300 m\Omega$	
BUS_I2C0_IRQ		Resistance $< 300 m\Omega$	
BUS_I2C1_SDA		Resistance $< 300 m\Omega$	
BUS_I2C1_SCL		Resistance $< 300 m\Omega$	
BUS_I2C1_IRQ		Resistance < $300m\Omega$	
BUS_SPI_SCK		Resistance $< 300 m\Omega$	
BUS_SPI_MISO		Resistance $< 300 m\Omega$	
BUS_SPI_MOSI		Resistance $< 300 m\Omega$	
CTRL_RESET		Resistance $< 300 m\Omega$	
COM_SPI_SCK		Resistance $< 300m\Omega$	
COM_SPI_MISO		Resistance < $300m\Omega$	
COM_SPI_MOSI		Resistance $< 300m\Omega$	
COM_SPI_CS		Resistance $< 300 m\Omega$	
BUS_JTAG_TCK		Resistance $< 300m\Omega$	
BUS_JTAG_TDI		Resistance $< 300m\Omega$	





Measure the resistance between each power channel and the power ground from Slot 0 to Slot 7.			
Power Channel	Resistance	Passing Criteria	Pass / Fail
BUS_JTAG_TDO		Resistance $< 300m\Omega$	
BUS_JTAG_TMS		Resistance $< 300m\Omega$	
BUS_JTAG_EN-0		Resistance < $300m\Omega$	
BUS_JTAG_EN-1		Resistance < $300m\Omega$	
BUS_JTAG_EN-2		Resistance < $300m\Omega$	
BUS_JTAG_EN-3		Resistance < $300m\Omega$	
GPIO-0		Resistance < $300m\Omega$	
GPIO-1		Resistance < $300m\Omega$	
GPIO-2		Resistance < $300m\Omega$	
GPIO-3		Resistance < $300m\Omega$	
GPIO-4		Resistance < $300m\Omega$	
GPIO-5		Resistance < $300m\Omega$	
GPIO-6		Resistance < $300m\Omega$	
GPIO-7		Resistance < $300m\Omega$	

3.3 Isolation

Results: Pass

Test Configuration: Elvis

This test evaluates the circuit described in Card Connectors.

3.3.1 Test Instructions

Measure the resistance of each net on the card connector to every other net.

3.3.2 Test Data

Measure the resistance of each net on the card connector to every other		
Net	Passing Criteria	Pass / Fail
PR_3.3V-0	All resistances > $10M\Omega$	
PR_3.3V-1	All resistances > $10M\Omega$	
PR_3.3V-2	All resistances > $10M\Omega$	
PR_3.3V-3	All resistances > $10M\Omega$	
PR_3.3V-4	All resistances > $10M\Omega$	
PR_3.3V-5	All resistances > $10M\Omega$	
PR_3.3V-6	All resistances > $10M\Omega$	
PR_3.3V-7	All resistances > $10M\Omega$	
PR_3.3V-8	All resistances > $10M\Omega$	
PR_3.3V-9	All resistances > $10M\Omega$	
PR_3.3V-10	All resistances > $10M\Omega$	
PR_3.3V-11	All resistances > $10M\Omega$	
PR_3.3V-12	All resistances > $10M\Omega$	
PR_BATT-0	All resistances > $10M\Omega$	
PR_BATT-1	All resistances > $10M\Omega$	
PR_BATT-2	All resistances > $10M\Omega$	
PR_BATT-3	All resistances > $10M\Omega$	·
PR_BATT-4	All resistances > $10M\Omega$	





Measure the resistance of each net on the card connector to every other ne		
Net	Passing Criteria	Pass / Fail
PR_BATT-5	All resistances > $10M\Omega$	
PR_BATT-6	All resistances > $10M\Omega$	
PGND	All resistances > $10M\Omega$	
PWR_CTRL_SW	All resistances > $10M\Omega$	
BUS_I2C0_SDA	All resistances > $10M\Omega$	
BUS_I2C0_SCL	All resistances > $10M\Omega$	
BUS_I2C0_IRQ	All resistances > $10M\Omega$	
BUS_I2C1_SDA	All resistances > $10M\Omega$	
BUS_I2C1_SCL	All resistances > $10M\Omega$	
BUS_I2C1_IRQ	All resistances > $10M\Omega$	
BUS_SPI_SCK	All resistances > $10M\Omega$	
BUS_SPI_MISO	All resistances > $10M\Omega$	
BUS_SPI_MOSI	All resistances > $10M\Omega$	
CTRL_SYNC	All resistances > $10M\Omega$	
COM_SPI_SCK	All resistances > $10M\Omega$	
COM_SPI_MISO	All resistances > $10M\Omega$	
COM_SPI_MOSI	All resistances > $10M\Omega$	
COM_SPI_CS	All resistances > $10M\Omega$	
BUS_JTAG_TCK	All resistances > $10M\Omega$	
BUS_JTAG_TDI	All resistances > $10M\Omega$	
BUS_JTAG_TDO	All resistances > $10M\Omega$	
BUS_JTAG_TMS	All resistances > $10M\Omega$	
BUS_JTAG_EN-0	All resistances > $10M\Omega$	
BUS_JTAG_EN-1	All resistances > $10M\Omega$	
BUS_JTAG_EN-2	All resistances > $10M\Omega$	
BUS_JTAG_EN-3	All resistances > $10M\Omega$	
GPIO-0	All resistances > $10M\Omega$	
GPIO-1	All resistances > $10M\Omega$	
GPIO-2	All resistances > $10M\Omega$	
GPIO-3	All resistances > $10M\Omega$	
GPIO-4	All resistances > $10M\Omega$	
GPIO-5	All resistances > $10M\Omega$	
GPIO-6	All resistances > $10M\Omega$	
GPIO-7	All resistances > $10M\Omega$	



